AN14512 How to Trim the Clock on MCX A Series Rev. 1.0 — 21 November 2024

Application note

Document information

Information	Content
Keywords	AN14512, MCXA, Trim clock, SCG, FIRC, SIRC
Abstract	This application note introduces the SCG module in MCX A series and describes how to trim the clock on MCX A series.



1 Introduction

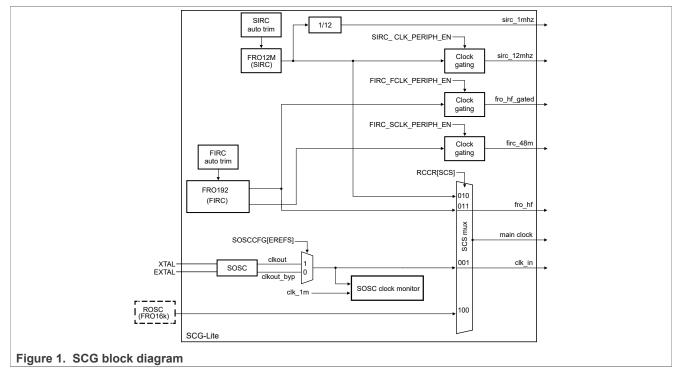
The MCX A series microcontrollers, powered by the Arm Cortex-M33, are general-purpose MCUs designed to address a wide range of applications with scalable device options, low power, and intelligent peripherals. MCX A series provide multiple clock sources, including System Oscillator Clock (SOSC), Slow Internal Reference Clock (SIRC, FRO12M), Fast Internal Reference Clock (FIRC, FRO192M), and Real-Time Oscillator Clock (ROSC). The System Clock Generator (SCG) module can be used to control these clocks, where FIRC and SIRC support manual trimming and auto trimming functions. Under open loop conditions, the accuracy of FIRC and SIRC is ± 3 %. In applications requiring higher accuracy, the auto trimming function can be used to improve clock accuracy. When auto trimming is enabled, FIRC and SIRC can achieve ± 0.25 % and ± 0.6 % accuracy respectively. This application note introduces the SCG module in MCX A series and describes how to trim the clock on MCX A series.

2 System Clock Generator (SCG) overview

The SCG module provides the main clock and other peripheral clocks for the MCU. The SCG takes clock inputs from various sources and generates the clocks that the MCU requires.

2.1 Function

Figure 1 shows the block diagram of the SCG module.



The system boots up from the FIRC source. The system clock can be switched among the following clock sources: FIRC, SIRC, SOSC, and ROSC.

- FIRC (FRO192M)
 - FIRC can output 192/96/64/48 MHz clock by register configuration.
 - FIRC can limit output frequency by frequency phantom.

- FIRC with trim capability.

- SIRC (FRO12M)
 - SIRC can output 12 MHz clock and 1 MHz clock divided from it.
 - SIRC with trim capability.
- SOSC
 - An external crystal is required, ranged from 8 MHz to 50 MHz.
- ROSC
 - ROSC is sourced from the FRO16K clock in VBAT block.

3 Software design

This section describes the steps for trimming the clock and provides sample code. The code is based on FRDM-MCXA153 SDK 2.16.1 and uses FRDM-MCXA153 as the test platform.

3.1 Manual trimming

The FIRC clock is calibrated before the chip is delivered, and the trim values are recorded in the FIRC Trim register (FIRCTRIM) after reset. The user can manually trim the clock using the FIRCTRIM, as shown in Figure 2.

Diagram																	
	Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	R		0	TRIMSTART			0			TRIMTEMP2		0					
	w																
	Reset	0	0	u ¹	u	u	u	u	u	0	0	0	0	u ¹	u	0	0
	Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	R		0		TRIMCOAR				TRIMFINE								
	w			1					TRIVIEINE								
	Reset	0	0	u ¹	u	u	u	u	u	u ¹	u	u	u	u	u	u	u
Figure 2. FII	RC trii	n re	gister			-				-				-			

There are two kinds of trim accuracy:

- TRIMCOAR bits are used to coarsely trim the FIRC Clock to within approximately ±3.2 % of the target frequency.
- TRIMFINE bits are used to fine trim the FIRC Clock to within approximately ±0.25 % of the target frequency.

Note: For TRIMCOAR, increasing the value makes the frequency lower. The frequency change rate near the center is about 2.5 % per bit, and the higher the value, the smaller the change rate. For TRIMFINE, increasing the value makes the frequency higher. The frequency change rate near the center is about 0.06 % per bit, and the higher the value, the smaller the change rate.

To manual trim the FIRC clock, follow the steps below:

- 1. Read the value from FIRCTRIM and record it.
- 2. Write 0x5A5A to TRIM_LOCK[TRIM_LOCK_KEY] and 1 to TRIM_LOCK[TRIM_UNLOCK] to unlock trim registers.
- 3. Add the trim value to the value recorded in <u>Step 1</u>.
- 4. Write **0x5A5A** to TRIM_LOCK[TRIM_LOCK_KEY] and **0** to TRIM_LOCK[TRIM_UNLOCK] to lock the trim registers.

The core code for FIRC manual trimming is as follows:

```
typedef enum
 TRIM COARSE,
 TRIM FINE
} trim type;
/**
 * @brief app_ FircManualTrim Manual TrimFIRC clock
* @param type
                   TRIM COARSE about 2.5%, TRIM FINE about 0.06%
                   value FIRCTRIM + value
 * @return NULL
*/
void app FircManualTrim(trim type type, char value)
 uint32_t trim_value = SCG0 -> FIRCTRIM;
 uint8_t trim_coarse = (uint8_t)(trim_value >> 8);
uint8_t trim_fine = (uint8_t)trim_value;
 PRINTF("%x\r\n", trim_value);
  /* UNLOCK the trim */
 SCG0 -> TRIM LOCK = (SCG TRIM_LOCK_TRIM_LOCK_KEY(0x5A5A)) |
 (SCG TRIM LOCK TRIM UNLOCK (1));
  if (type == TRIM COARSE)
                              // coarse trim mode, use coarse trim register
    trim coarse = trim coarse + value;
    SCG0 -> FIRCTRIM = (trim_value & 0xFFFF0000) | (trim_fine & 0xff) | ((trim_coarse &
 0x3f) << 8);
  }
  else if(type == TRIM FINE) // fine trim mode, use fine trim register
  {
    trim fine = trim fine + value;
    SCGO -> FIRCTRIM = (trim value & 0xFFFF0000) | (trim fine & 0xff) | ((trim coarse &
 0x3f) << 8);
 trim value = SCG0 -> FIRCTRIM;
  /* LOCK the trim */
  SCG0 -> TRIM LOCK = (SCG TRIM LOCK TRIM LOCK KEY(0x5A5A)) |
 (SCG TRIM LOCK TRIM UNLOCK(0));
  PRINTF("%x\r\n", trim value);
}
```

3.2 Auto trimming

The accuracy of FIRC and SIRC is $\pm 3 \%$ (Ta = -40 °C ~ 125 °C), in some use cases, a higher precision clock is required, in which case the auto trimming function is useful. After auto trimming, FIRC and SIRC can achieve $\pm 0.25 \%$ and $\pm 0.6 \%$ accuracy respectively.

An external crystal is required as a reference source to trim the clock.

To auto trim the FIRC clock, follow the steps below:

- 1. Enable the SOSC clock.
- 2. Wait until the SOSC clock is valid.
- 3. Write 2 to FIRCTCFG[TRIMSRC] to select SOSC as the auto trim clock source.
- 4. Write 7 to FIRCTCFG[TRIMDIV] to divide SOSC to 1 MHz (8 MHz external crystal).
- 5. Write **0** to FIRCCSR[LK] to unlock the FIRCCSR.
- 6. Write 1 to FIRCCSR[FIRCTREN] to enable the auto trim.
- 7. Write 1 to FIRCCSR[FIRCTRUP] to enable the update.
- 8. Read FIRCCSR[FIRCVLD] until it returns 1, indicating that the FIRC is valid.
- 9. Read FIRCCSR[FIRCERR] to ensure that it returns 0.

10. Read FIRCCSR[TRIM_LOCK] until it returns **1**.

11. Write 1 to FIRCCSR[LK] to lock the <code>FIRCCSR</code>.

The core code for FIRC auto trimming is as follows:

```
* @brief
                app FircAutoTrim Run Auto Trim to trim the clock using external crystal
 * @param NULL
* @return NULL
void app FircAutoTrim()
CLOCK SetupExtClocking(800000U);
                                                       // Enable the 8MHz external crystal
 SCG0 -> FIRCTCFG |= SCG FIRCTCFG TRIMSRC(2);
                                                       // Select the external crystal (SOSC) as the source
                                                       // Divide the SOSC to 1MHz
 SCG0 -> FIRCTCFG |= SCG FIRCTCFG TRIMDIV(7);
SCG0 -> FIRCCSR &= ~SCG FIRCCSR LK(1);
SCG0 -> FIRCCSR |= SCG_FIRCCSR_FIRCTREN(1);
                                                        // Unlock the FIRCCSR register
                                                       // Enable auto trim
SCG0 -> FIRCCSR |= SCG FIRCCSR FIRCTRUP(1); //
/* Until it returns 1, Indicating FIRC is valid */
                                                        // Enable update
 while(!(SCG0 -> FIRCCSR & SCG FIRCCSR FIRCVLD MASK));
 /* Until it returns 0, indicating no error */
   ile( SCG0 -> FIRCCSR & SCG_FIRCCSR_FIRCERR_MASK);
Until it returns 1, indicating FIRC auto trim locked to target frequency range */
while(
 while(!(SCG0 -> FIRCCSR & SCG FIRCCSR_TRIM_LOCK_MASK));
SCG0 -> FIRCCSR |= SCG FIRCCSR LK(1);
                                                        // Lock the FIRCCSR register
}
```

To auto trim the SIRC clock, follow the steps below:

- 1. Enable the SOSC clock.
- 2. Wait until the SOSC clock is valid.
- 3. Write 2 to SIRCTCFG[TRIMSRC] to select SOSC as the auto trim clock source.
- 4. Write 7 to SIRCTCFG[TRIMDIV] to divide SOSC to 1 MHz (8 MHz external crystal).
- 5. Write 0 to SIRCCSR[LK] to unlock the SIRCCSR.
- 6. Write 1 to SIRCCSR[SIRCTREN] to enable the auto trim.
- 7. Write 1 to SIRCCSR[SIRCTRUP] to enable the update.
- 8. Read SIRCCSR[SIRCVLD] until it returns 1, indicating that the SIRC is valid.
- 9. Read SIRCCSR[SIRCERR] to ensure that it returns 0.
- 10. Read SIRCCSR[TRIM LOCK] until it returns 1.
- 11. Write 1 to SIRCCSR[LK] to lock the SIRCCSR.

The core code for SIRC auto trimming is as follows:

```
/**
 * @brief
             app SircAutoTrim Run Auto Trim to trim the clock using external crystal
 * @param
           NULL
 * @return NULL
* /
void app SircAutoTrim()
 CLOCK SetupExtClocking(800000U);
                                                     // Enable the 8MHz external crystal
SCG0 -> SIRCTCFG |= SCG SIRCTCFG TRIMSRC(2);
SCG0 -> SIRCTCFG |= SCG_SIRCTCFG_TRIMDIV(7);
                                                     // Select the external crystal(SOSC) as the source
                                                     // Divide the SOSC to 1MHz
                                                     // Unlock the SIRCCSR register
 SCG0 -> SIRCCSR &= ~SCG SIRCCSR LK(1);
SCG0 -> SIRCCSR |= SCG SIRCCSR SIRCTREN(1);
SCG0 -> SIRCCSR |= SCG_SIRCCSR_SIRCTRUP(1);
                                                     // Enable auto trim
                                                     // Enable update
 /* Until it returns 1, indicating SIRC is valid *,
 while(!(SCG0 -> SIRCCSR & SCG SIRCCSR SIRCVLD MASK));
 /* Until it returns 0, indicating no error */
 while ( SCG0 -> SIRCCSR & SCG SIRCCSR SIRCERR MASK);
 /* Until it returns 1, indicating SIRC auto trim locked to target frequency range */
 while(!(SCG0 -> SIRCCSR & SCG SIRCCSR TRIM LOCK MASK));
 SCG0 -> SIRCCSR |= SCG_SIRCCSR_LK(1);
                                                   // Lock the SIRCCSR register
}
```

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Note: Configure the required peripherals after trimming the clock.

3.3 Clock output

The clock output function is a useful feature for clock observing. Some pins can be configured as clock output pin, refer to the reference manual SYSCON section for more detail. Take the MCXA153 as an example, configure P0_6, P3_6, or P3_8 as the clock output pin. After configuring the pin, set the SYSCON and MRCC registers as follows:

- 1. Write **0** to CLKUNLOCK [UNLOCK] to unlock the clock configuration registers.
- 2. Write 1 to MRCC_CLKOUT_CLKSEL[MUX] to select FIRC_DIV as the clock source (when measuring SIRC, write 0 to MRCC_CLKOUT_CLKSEL[MUX]).
- 3. Write **15** to MRCC_CLKOUT_CLKDIV[DIV] to set the divider value to **16** (when measuring SIRC, write **11** to MRCC_CLKOUT_CLKSEL[MUX]).
- 4. Write 1 to CLKUNLOCK [UNLOCK] to lock the clock configuration registers.

The core code for clock output configuration is as follows:

```
/* PORT3: Peripheral clock is enabled */
    CLOCK EnableClock(kCLOCK GatePORT3);
      /* PORT3 peripheral is released from reset */
    RESET ReleasePeripheralReset(kPORT3 RST SHIFT RSTn);
     const port_pin_config_t port3_8_config = {/* Internal pull-up resistor is enabled */
                                                              kPORT PullUp,
                                                              /* Low internal pull resistor value is selected. */
                                                              kPORT LowPullResistor,
                                                              /* Fast slew rate is configured */
                                                             kPORT FastSlewRate,
                                                              /* Passive input filter is disabled */
                                                             kPORT PassiveFilterDisable,
                                                              /* Open drain output is disabled */
                                                             kPORT OpenDrainDisable,
                                                              /* Low drive strength is configured */
                                                             kPORT LowDriveStrength,
                                                              /* Normal drive strength is configured */
                                                             kPORT NormalDriveStrength,
                                                              /* Pin is configured as CLKOUT */
                                                             kPORT MuxAlt12,
                                                              /* Digital input enabled */
                                                             kPORT InputBufferEnable,
                                                              /* Digital input is not inverted */
                                                              kPORT_InputNormal,
                                                              /* Pin Control Register fields [15:0] are not locked */
                                                             kPORT UnlockRegister};
     /* PORT3 8 is configured as CLK OUT *,
    PORT SetPinConfig(PORT3, 8U, &port3 8 config);
/**
  * @brief
                                 app ClockOut clock output set, to observe clock signal
  * @param
                                 NULL
   * @return NULL
*/
void app ClockOut()
 SYSCON -> CLKUNLOCK = SYSCON_CLKUNLOCK_UNLOCK(0); // Unlock the register
MRCC0 -> MRCC_CLKOUT_CLKSEL = MRCC_MRCC_CLKOUT_CLKSEL_MUX(1); // FIRC_DIV
MRCC0 -> MRCC_CLKOUT_CLKDIV = MRCC_MRCC_CLKOUT_CLKDIV_DIV(15); // 1/16 Frequency
SYSCON -> CLKUNLOCK = SYSCON_CLKUNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_UNLOCK_U
                                                                                                                                                                      // Lock the register
  SYSCON -> CLKUNLOCK
                                                                          = SYSCON CLKUNLOCK UNLOCK (0);
}
```

4 Test on Board

To test the clock trimming functions, the FRDM-MCXA153 board is used, as shown in <u>Figure 3</u>. The board ships with an onboard debugger. Use a USB-C cable to connect the board to the computer via J15 for downloading and debugging. In this test, P3_8 is used as the clock output pin. Connect the P3_8 (J3-11 on board) and GND to the oscilloscope probe, and capture the output signal.



Figure 3. FRDM-MCXA153 board

4.1 Test result

When measuring the FIRC frequency, write **15** to MRCC_CLKOUT_CLKDIV[DIV] to set the divider value to **16**. In this test, set FIRC to 96 MHz and output the clock through P3_8. Before trimming, the clock output shows below, the frequency is about 6.045 MHz, about 1/16 of 96 MHz, as shown in Figure 4.



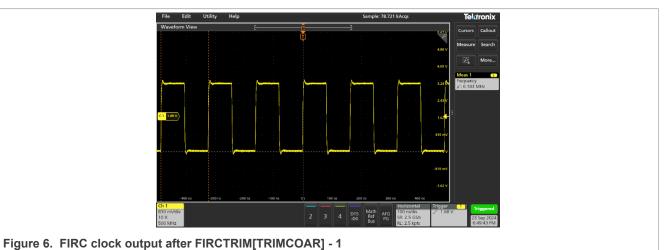
If **1** is added to FIRCTRIM[TRIMCOAR], the frequency is about 5.911 MHz, and the frequency decreases by about 2.2 %, as shown in Figure 5.

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Figure 5. FIRC clock output after FIRCTRIM[TRIMCOAR] + 1

If -1 is added to FIRCTRIM[TRIMCOAR], the frequency is about 6.183 MHz, and the frequency increases by about 2.3 %, as shown in Figure 6.



If **4** is added to <code>FIRCTRIM[TRIMFINE]</code>, the frequency is about 6.059 MHz, and the frequency increases by about 0.23 %, as shown in Figure 7.

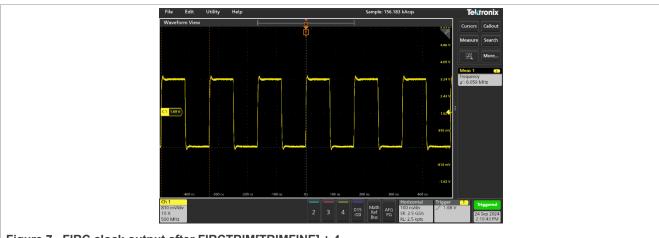


Figure 7. FIRC clock output after FIRCTRIM[TRIMFINE] + 4

If -4 is added to <code>FIRCTRIM[TRIMFINE]</code>, the frequency is about 6.032 MHz, and the frequency decreases by about 0.22 %, as shown in Figure 8.



Figure 8. FIRC clock output after FIRCTRIM[TRIMFINE] - 4

After running the FIRC auto trimming function, the frequency is about 6.000 MHz, as shown in Figure 9. The accuracy of the FIRC clock has been improved.

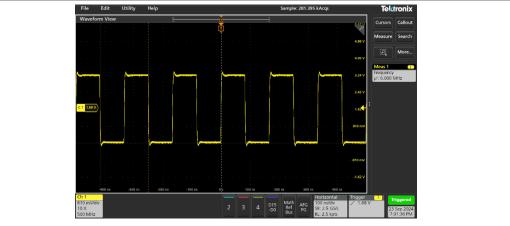
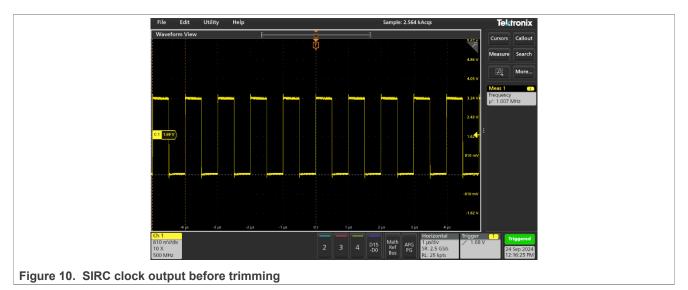


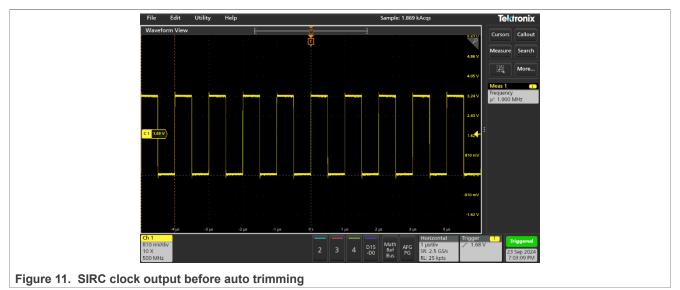
Figure 9. FIRC clock output after auto trimming

When measuring the SIRC frequency, write **11** to $MRCC_CLKOUT_CLKDIV[DIV]$ to set the divider value to **12**. In this test, SIRC is set to 12 MHz and output the clock through P3_8. Before trimming, the clock output shows below, and the frequency is about 1.007 MHz, about 1/12 of 12 MHz, as shown in Figure 10.

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After running the SIRC auto trimming function, the frequency is about 1.000 MHz, as shown in <u>Figure 11</u>. The accuracy of the SIRC clock has been improved.



5 Conclusion

This application note provides some information and code to help the user trim the clock on MCX A series and do a test to verify the clock output.

6 Note about the source code in the document

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7 Revision history

Table 1 summarizes the revisions to this document.

Table 1.	Revision	history
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Document ID	Release date	Description
AN14512 v.1.0	21 November 2024	Initial public release

How to Trim the Clock on MCX A Series

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